

2N6400-2N6405

SILICON CONTROLLED RECTIFIERS

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak repetitive off-state voltage (1)				
$(T_J = -40 \text{ to } 125^{\circ}\text{C}, \text{ sine wave } 50 \text{ to } 60\text{Hz}, \text{ gate open})$				
2N6400		50		
2N6401	V_{DRM}	100	Volts	
2N6402	V_{RRM}	200	Voits	
2N6403		400		
2N6404		600		
2N6405		800		
On-state RMS current			A	
(180° conduction angles), $T_C = 100$ °C)	I _{T(RMS)}	16	Amps	
Average on-state current			A	
(180° conduction angles, $T_C = 100$ °C)	I _{T(AV)}	10	Amps	
Peak non-repetitive surge current			A	
(1/2 cycle, sine wave 60Hz, $T_J = 90$ °C)	I _{TSM}	160	Amps	
Circuit fusing (t = 8.3ms)	I ² t	145	A ² s	
Forward peak gate power	D		Watts	
(pulse width $\leq 1.0 \mu s$, $T_C = 100$ °C)	P _{GM}	20	Walts	
Forward average gate power			Watts	
$(t = 8.3 \text{ms}, T_C = 100^{\circ}\text{C})$	P _{G(AV)}	P _{G(AV)} 0.5		
Forward peak gate current			A	
(Pulse width $\leq 1.0 \mu s$, $T_c = 100 ^{\circ} C$)	I _{GM}	2.0	Amps	
Operating junction temperature range	T _J	-40 to 125	°C	
Storage temperature range	T _{stg}	-40 to 150	°C	

^{1.} V_{DBM} and V_{RBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage, however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

Characteristic		Max	Unit
Thermal resistance, junction to case	R _{eJC}	1.5	°C/W
Maximum lead temperature for soldering purposes 1/8" from case for 10 seconds		260	°C

ELECTRICAL CHARACTERISTICS (T_C = 25°C)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak repetitive forward or reverse blocking current						
$(V_{AK} = rated V_{DRM} or V_{RRM}, gate open)$	T _J = 25°C		-	-	10	μΑ
	T _J = 125°C	I _{DRM} , I _{RRM}	-	-	2.0	mA
ON CHARACTERISTICS				-		
Peak forward on-state voltage						Volte
$(I_{TM} = 32A \text{ peak, pulse width} \le 1 \text{ms, duty cycle} \le 2\%)$		V _{TM}	-	-	1.7	Volts



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ELECTRICAL CHARACTERISTICS (T_C = 25°C)

ON CHARACTERISTICS						
Gate trigger current (continuous dc)						
$(V_D = 12Vdc, R_L = 100ohms)$	T _C = 25°C	I _{GT}	-	9.0	30	mA
	$T_C = -40$ °C		-	-	60	
Gate trigger voltage (continuous dc)						
$(V_D = 12Vdc, R_L = 100ohms)$	T _C = 25°C	V_{GT}	-	0.7	1.5	Volts
	T _C = -40°C		-	-	2.5	
Gate non-trigger voltage		V				Volts
$(V_D = 12Vdc, R_L = 100ohms)$	T _C = 125°C	$V_{\sf GD}$	0.2	-	-	Volts
Holding current						
(V _D = 12Vdc, initiating current = 200mA, gate open)	T _C = 25°C	I _H	-	18	40	mA
	T _C = -40°C		-	-	60	
Turn-on time						
$(I_{TM} = 16A, I_{GT} = 40 \text{mAdc}, V_D = \text{rated } V_{DRM})$		t _{gt}	-	1.0	-	μs
Turn-off time						
$(I_{TM} = 16A, I_R = 16A, V_D = rated V_{DRM})$	T _C = 25°C	tq	-	15	-	μs
	T _J = 125°C		-	35	-	
DYNAMIC CHARACTERISTICS	·					
Critical rate of rise of off state voltage		1.7%		\// ·		
$(V_D = rated V_{DRM}, exponential waveform)$	T _J = 125°C	dv/dt	-	50	-	V/µs

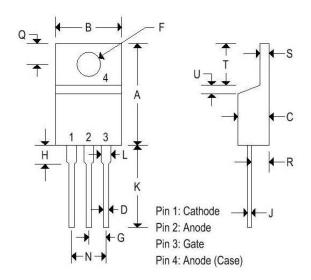


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MECHANICAL CHARACTERISTICS

Case:	TO-220AB			
Marking:	Body painted, alpha-numeric			
Pin out:	See below			

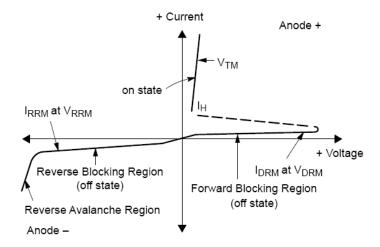


	TO-220 A B					
	Inches		Millim	eters		
	Min Max		Min	Max		
Α	0.575	0.620	14.600	15.750		
В	0.380	0.405	9.650	10.290		
С	0.160	0.190	4.060	4.820		
D	0.025	0.035	0.640	0.890		
F	0.142	0.147	3.610	3.730		
G	0.095	0.105	2.410	2.670		
Н	0.110	0.155	2.790	3.930		
J	0.014	0.022	0.360	0.560		
K	0.500	0.562	12.700	14.270		
L	0.045	0.055	1.140	1.390		
N	0.190	0.210	4.830	5.330		
Q	0.100	0.120	2.540	3.040		
R	0.080	0.110	2.040	2.790		
S	0.045	0.055	1.140	1.390		
Т	0.235	0.255	5.970	6.480		
U	-	0.050		1.270		
٧	0.045	120	1.140	848		
Z	-	0.080	16	2.030		



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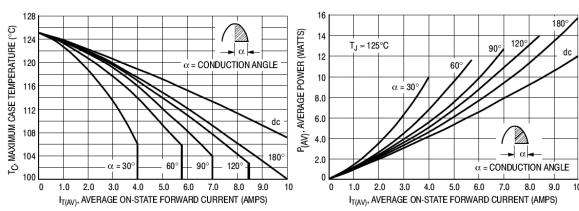


Figure 1. Average Current Derating

Figure 2. Maximum On-State Power Dissipation



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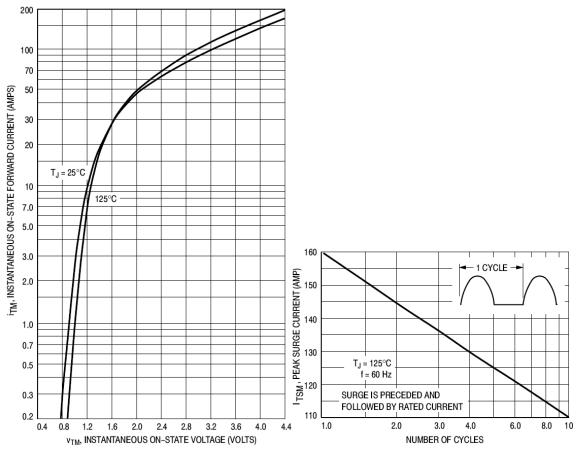


Figure 3. On-State Characteristics

Figure 4. Maximum Non-Repetitive Surge Current

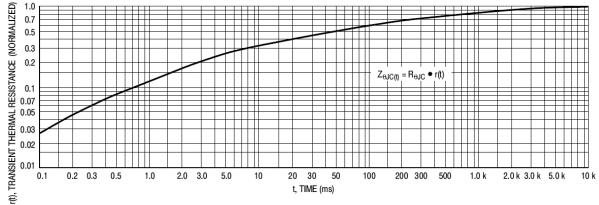
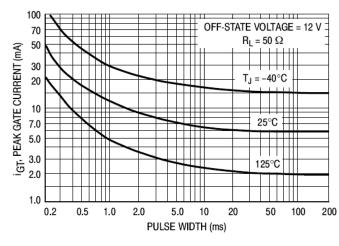


Figure 5. Thermal Response



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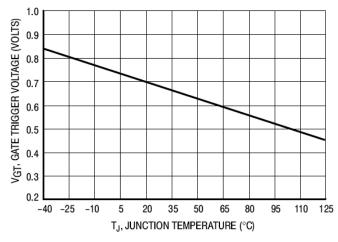
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100 (Am) 100

Figure 6. Typical Gate Trigger Current versus Pulse Width

Figure 7. Typical Gate Trigger Current versus Junction Temperature



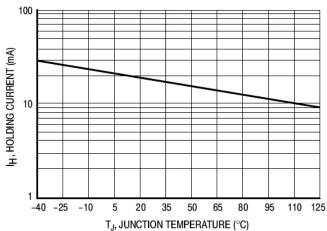


Figure 8. Typical Gate Trigger Voltage versus Junction Temperature

Figure 9. Typical Holding Current versus Junction Temperature